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FDS4672A

40V N-Channel PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{\text{DS}(\text{ON})}$ and fast switching speed.

Applications

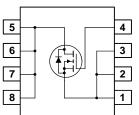
DC/DC converter

Features

- 11 A, 40 V. $R_{\text{DS(ON)}}$ = 13 m Ω @ V_{GS} = 4.5 V
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low gate charge (35 nC typical)
- High power and current handling capability
- RoHS Compliant







Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol		Parameter		Ratings	Units
V _{DSS}	Drain-Sourc	e Voltage		40	V
V _{GSS}	Gate-Source	e Voltage		±12	V
I _D	Drain Curre	nt – Continuous	(Note 1a)	11	A
		– Pulsed		50	
E _{AS}	Single Pulse	e Avalanche Energy	(Note 3)	181	mJ
P _D	Power Dissi	pation for Single Operation	(Note 1a)	2.5	W
			(Note 1b)	1.4	
			(Note 1c)	1.2	
T _J , T _{STG}	Operating a	Operating and Storage Junction Temperature Range		-55 to +175	°C
Therma	I Charact	eristics			
R _{0JA}	Thermal Resistance, Junction-to-Ambient		nt (Note 1a)	50	°C/W
R _{0JC}	Thermal Re	rmal Resistance, Junction-to-Case		25	
Packag	e Marking	g and Ordering In	formation		
Device Marking			Reel Size	Tape width	Quantity
FDS4672A		FDS4672A	13"	12mm	2500 units

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FDS4672A Rev C1 (W)

FDS4672A

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chai	racteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	40			V
ΔBV _{DSS} ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		37		mV/°0
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 32 V, V_{GS} = 0 V$			1	μA
IGSSF	Gate-Body Leakage, Forward	$V_{GS} = 12 V$, $V_{DS} = 0 V$			100	nA
IGSSR	Gate-Body Leakage, Reverse	$V_{GS} = -12 V V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.8	1.2	2.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-4		mV/°0
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 11 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 11 \text{ A}, T_J = 125^{\circ}\text{C}$		10 15	13 21	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	50			Α
g _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 11 A$		65		S
Dvnami	c Characteristics	•		•		
C _{iss}	Input Capacitance	$V_{DS} = 20 V$, $V_{GS} = 0 V$,		4766		pF
Coss	Output Capacitance	f = 1.0 MHz		346		pF
C _{rss}	Reverse Transfer Capacitance			155		pF
Switchir	ng Characteristics (Note 2)	-	1			
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 20 V, I_D = 1 A,$		17	31	ns
tr	Turn–On Rise Time	$V_{GS} = 4.5$ V, $R_{GEN} = 6 \Omega$		9	18	ns
t _{d(off)}	Turn–Off Delay Time			43	68	ns
t _f	Turn–Off Fall Time	-		14	25	ns
Q _g	Total Gate Charge	$V_{DS} = 20 V, I_D = 11 A,$		35	49	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		7.8		nC
Q _{gd}	Gate–Drain Charge			8.8		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
I _s	Maximum Continuous Drain–Source				2.1	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 2.1 A$ (Note 2)		0.7	1.2	V

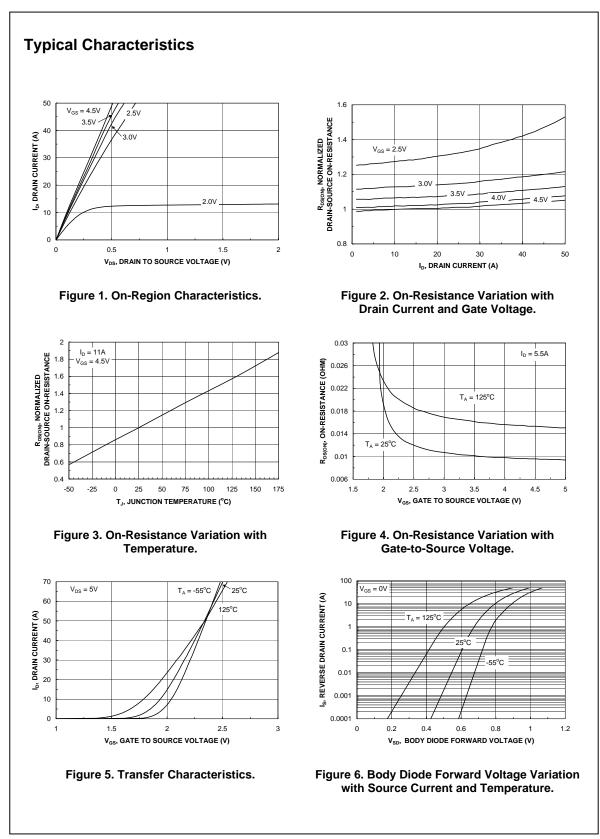
Scale 1 : 1 on letter size paper

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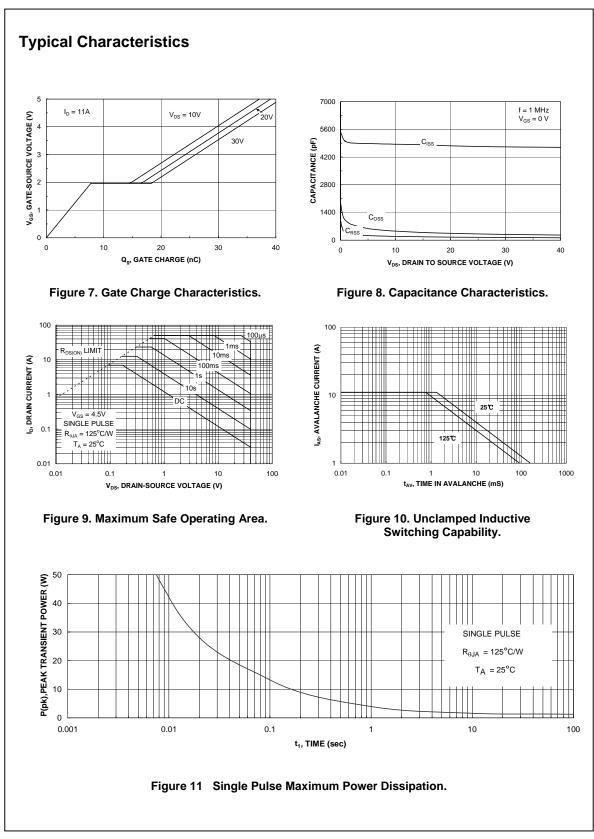
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

 $\textbf{3}. Starting \; \textbf{T}_{J} = 25^{o} \textbf{C}, \; \textbf{L} = 3 \textbf{m} \textbf{H}, \textbf{I}_{D} = 11 \textbf{A}, \; \textbf{V}_{DD} = 40 \textbf{V}, \; \textbf{V}_{GS} = 10 \textbf{V}$

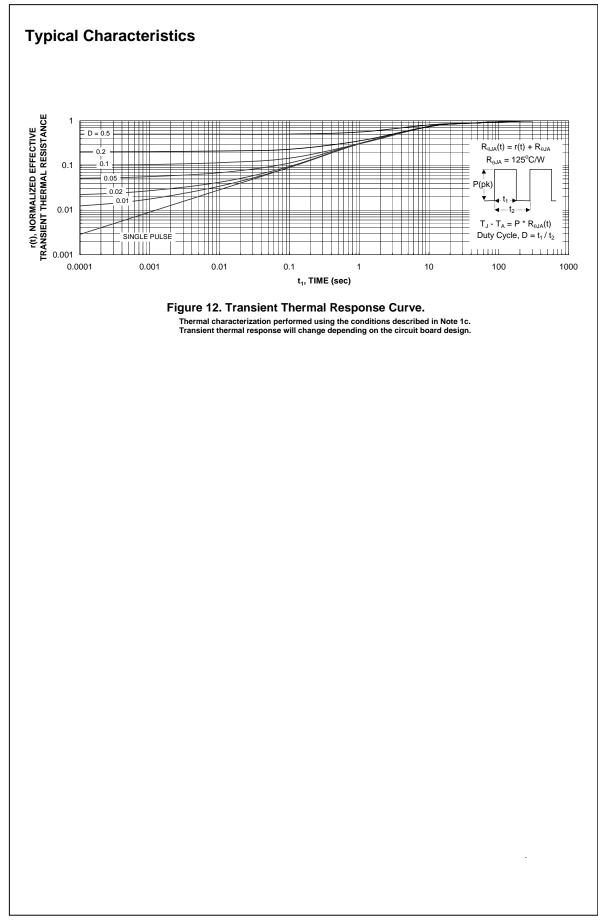
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